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BOND Brothers appoints Mead as vice president of technology

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Boston, MA BOND Brothers, Inc., has appointed Matthew Mead as vice president of technology, a critical executive position at the construction management and civil & utility general contracting firm. This strategic move underscores BOND's commitment to leveraging cutting-edge technology and pursuing continuous innovation through transformative and visionary leadership.

“Even with top-tier technology, building teams and synergy is critical and that’s where Matt comes in – to help us seamlessly align the strengths of our people with the power of technology,” said Anthony Bond, CEO and president of BOND Brothers. “He brings a wealth of experience and a proven ability to transform technology into the engine that drives innovation and growth. It’s an exciting time in the industry, and with Matt’s leadership and expertise, we’re confident he can unlock our full potential in the technology space as a catalyst to propel BOND to new heights.”

Mead will spearhead efforts in developing, coordinating and executing all facets of BOND's technological roadmap. He will oversee the delivery of IT services and advance the company's use of new tools, data modeling, predictive analytics and artificial intelligence by providing strategic insight, driving value creation, and improving business planning and forecasting.

“The construction ecosystem is very fragmented, which presents a unique challenge when it comes to efficient and effective use of technology. Yet technology is changing the industry at a rapid rate, and we either change with it or get left behind. Leveraging integrated, innovative technologies – including revolutionary elements such as AI – is critical to success and forward progress,” said BOND's new Vice President of Technology, Matthew Mead. “I am honored and excited to harness these emerging technologies, cultivate a culture of creativity and experimentation, and accelerate the pace of innovation here at BOND – a company that is fully prepared to embrace these opportunities. Together, we’ll amplify our capabilities, unveil new frontiers of possibility, and ultimately usher BOND towards a future of even greater innovation and success.”

Mead holds a bachelor's degree from Harvard University. Prior to BOND, he served as Chief Administrative and Information Officer at The Middlesex Corporation in Littleton, Massachusetts, where he led both business and technology operations.